## APPLICATION FOR UNITED STATES PATENT

**Declaration for Patent Application** 

As a below named inventor, I hereby declare that:

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My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: 1 TERMINAL AUTHENTICATING SYSTEM AND TERMINAL AUTHENTICATING

invention entit	led: 1 <u>TE</u>	RMINAL	AUTHENTICATI	NG SYSTEM	AND TERMINAL	_AUTHENTI	CATING	
METHOD A	AND TERM	INAL A	UTHENTICATING	SERVER				
the specification		213	in the distance	2 (file	e no		)	
(check at least	one)	3[] 4[] 6[]	is attached hereto was filed on and was amended		_ as (5) U.S. Application Serial No		<del></del>	
			(if applicable)					
Use this port only if you are er	ntering 'L'	-	was filed as PCT international application					
the U.S. National based on a Po	l phase 8		Number PCT/JP03/12318 on September 26, 2003					
Internation	_		nd was amended under PCT Article(s) 19 and/or 34					
Application design the U.S.	gnating 10			` ,			_(if applicable).	
	-		e reviewed and unde		nts of the above-id	lentified specif	ication, including the	
-	- •		ent referred to abov					
	_	•	disclose to the Unite accordance with Title				ition known to me	
	-	•		-	•		foreign application(s	
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America filed l claimed.	by me on the	e same su	bject matter having a	i filing date earl	ier than that of the	application(s)	on which priority is	
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Prior (Foreign)	Application	n(s) any P	riority Claims Unde	r 35 U.S.C. 119	or 365	Pric	ority Claimed	
Japan			2002-28	4334	Septembe	er 27, 2002	_[X][]	
(Country)			(Number	)	(Day/Month/Ye	ear Filed)	Yes No	
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[ ] Additiona	al foreign ap	plication	numbers are listed o	n a supplementa	l priority data shee	et attached here	eto.	
Priority Claim(	(c) from IIS	Provisio	nal Application(s) -	I hereby claim	the benefit under T	Fitle 25 United	L States Code	
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ALL CORRESPONDENCE IN CONNECTION WITH THIS APPLICATION SHOULD BE SENT TO STEVENS, DAVIS,

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful statements may jeopardize the validity of the application or any patent issuing thereon.

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